

Vishay Siliconix

# **Battery Disconnect Switch**

#### DESCRIPTION

The Si4720CY is two level-shifted P-Channel MOSFETs. Operating together, these MOSFETs can be used as a reverse blocking switch for battery disconnect applications. It is a solution for multiple battery technology designs or designs that require isolation from the power bus during charging.

The Si4720CY is available in a 16-pin SOIC package and is rated for the commercial temperature range of - 25  $^\circ\text{C}$  to 85  $^\circ\text{C}.$ 

### FEATURES

- Solution for Bi-Directional Blocking
- 6 V to 30 V Operation
- Ground Referenced Logic Level Inputs
- Integrated Low R<sub>DS(on)</sub> MOSFET
- Level-Shifted Gate Drive with Internal MOSFET
- Two Independent Inputs
- Ultra Low Power Consumption in Off State (Leakage Current Only)
- Logic Supply Voltage is Not Required

#### FUNCTIONAL BLOCK DIAGRAM



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ABSOLUTE MAXIMUM RATINGS					
Parameter	Symbol	Limit	Unit		
Voltage Referenced to GND $V_S$ , $V_D^a$			- 0.3 to 32		
V <sub>SD</sub>			- 0.3 to 30	v	
V <sub>IN1</sub> , V <sub>IN2</sub>			- 0.3 to 15	v	
V <sub>GS</sub>			20		
Storage Temperature			- 55 to 150	°C	
Power Dissipation <sup>b</sup>	t = 10 s		2.5	w	
	t = Steady State		1.5	vv	

Notes:

a.  $V_{SD} \leq 30 \ V_{DC}.$ 

b. Device mounted with all leads soldered to 1" x 1" FR4 with laminated copper PC board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE				
Parameter	Symbol	Limit	Unit	
V <sub>S</sub> , V <sub>D</sub>		6 to 30	v	
V <sub>IN1</sub> , V <sub>IN2</sub>		0 to 13.2	v	
I <sub>DS</sub>		0 to 6	А	
Operating Temperature Range - 25 to 85		°C		
Junction Temperature		- 25 to 150		

This device has a maximum recommended operating junction temperature of 85 °C. This temperature limit is used for electrical specifications such as logic transition voltages only and is not a reliability limit. The device can be used with junction temperatures up to 150 °C if relaxed specifications can be tolerated, although limits for these specifications may not be given. Performance curves can be used to give an indication of specifications at higher temperatures, but are not guaranteed.

SPECIFICATIONS								
Parameter			Test Conditions Unless Otherwise Specified		Limits			
		Symbol		Temp. <sup>a</sup>	Min. <sup>b</sup>	Typ. <sup>c</sup>	Max. <sup>b</sup>	Unit
On-Resistance		r <sub>DS</sub>	$V_{S} = 10 \text{ V}, I_{D} = 1 \text{ A}, V_{IN} = H$	Room		0.0155	0.020	Ω
Leakage Current		I <sub>DS(off)</sub>	V <sub>DS</sub> = 10 V	Room			1	
Supply Current		I <sub>S(off)</sub>	- V <sub>S</sub> = 21 V	Room			1	μΑ
		I <sub>S(on)</sub>		Room		1.1	6	
Input Voltage Low		V <sub>INL</sub>	$V_{\rm S}$ = 10 and $V_{\rm S}$ = 21	Full			1	v
Input Voltage High		V <sub>INH</sub>		Full	2.5			
Input Leakage Curr	rent	I <sub>INH</sub>	V <sub>IN</sub> = 5 V	Full			5	μΑ
Turn-On Delay	IN	t <sub>ON(IN)</sub>	V <sub>S</sub> = 10 V, R <sub>I</sub> = 5 Ω, Figure 1	Room	2.2	2.9	10	
Turn-Off Delay	to D or S	t <sub>OFF(IN)</sub>	$v_{\rm S} = 10$ v, $u_{\rm L} = 0.22$ , figure 1	Room		1.5	2.1	
Break-Before-Make <sup>d</sup>		t <sub>BBM</sub>		Room		1.05		μs
Rise Time		t <sub>RISE</sub>	$V_{S}$ = 10 V, $R_{L}$ = 5 $\Omega$ , Figure 1	Room		1.3	2.5	
Fall Time		t <sub>FALL</sub>	$v_{\rm S} = 10$ v, $n_{\rm L} = 5.22$ , Figure 1	Room		50	100	ns
Voltage Across pin	6 and 7	V <sub>GS</sub> V <sub>S</sub> = 30		Room		10.2	18	v
Forward Diode		V <sub>SD</sub>	I <sub>D</sub> = - 1 A	Room			1.1	v

Notes:

a. Room = 25  $^\circ\text{C},$  full = as determined by the operating temperature suffix.

b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum.

c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

d. Guaranteed by design, not subject to production testing.

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#### TIMING DIAGRAMS





Figure 1.

PIN CONFIGURATION AND TRUTH					
V <sub>IN1</sub>	V <sub>IN2</sub> Switch 1		Switch 2		
0	0	Off	Off		
0	1	Off	On		
1	0	On	Off		
1	1	On	On		



PIN DESCRIPTION (Subject to Change)			
Pin Number	Symbol	Description	
1, 2, 3	D <sub>2</sub>	Drain connection for MOSFET-2.	
4, 12	GND	Ground	
5	IN <sub>1</sub>	Logic input, IN <sub>1</sub> . High level turns on the switch.	
6	G <sub>1(OUT)</sub>	Gate output to MOSFET-1.	
7, 8	S <sub>1</sub>	Source connection for MOSFET-1.	
9, 10, 11	D <sub>1</sub>	Drain connection for MOSFET-1.	
13	IN <sub>2</sub>	Logic input, IN <sub>2</sub> . High level turns on the switch.	
14	G <sub>2(OUT)</sub>	Gate output to MOSFET-2.	
15, 16	S <sub>2</sub>	Source connection for MOSFET-2.	

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### TYPICAL CHARACTERISTICS (25 °C unless noted)







**On-Resistance vs. Source Voltage** 



**Output Capacitance vs. Source Voltage** 



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### TYPICAL CHARACTERISTICS (25 °C unless noted)





Input Voltage Trip Point vs. Temperature



Turn-off Delay vs. Temperature



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### TYPICAL CHARACTERISTICS (25 °C unless noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

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### **APPLICATION DRAWINGS**







Figure 3.

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### **APPLICATION DRAWINGS**



#### Figure 5. High-Performance Laptop PC

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SOIC (NARROW): 16-LEAD

JEDEC Part Number: MS-012







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